

# Antenna

# YC0010AA Datasheet

## Antenna Services

Version: 1.5

OC (Antenna Only): **YC0010AA**

OC (Antenna + EVB): **YC0010AAEVB**

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# About the Document

## Revision History

Version	Date	Author	Note
-	2020-09-22	Kenny YIN	Creation of the document
1.0	2020-09-22	Kenny YIN	First official release
1.1	2021-01-12	Kenny YIN	Updated the antenna image in Chapter 2.
1.2	2021-08-10	Aria CHU	Updated the data (Chapters 3 and 4.5).
1.3	2021-09-28	Aria CHU	Added the new OC YC0010AAEVB on the cover.
1.4	2021-11-30	Aria CHU	Updated the product description in Chapter 1.
1.5	2021-12-23	Aria CHU	Updated the data (Chapter 4.6).

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## 1 Product Description

Quectel Wi-Fi antenna covers 2.4 GHz, 5 GHz, and up to 7 GHz bands, fully satisfying customers' requirements for Wi-Fi 5, Wi-Fi 6, and Wi-Fi 6E. There are various antenna types, including built-in FPC antenna, ceramic patch antenna, and other external antennas of different shapes or sizes. The antenna performance meets the customers' demands for efficiency, gain, and radiation and ensures the superior experience of the customers' products in use.

We provide comprehensive antenna design support such as simulation, testing and manufacturing for custom antenna solutions to meet your specific application needs.

## 2 Product Features

- Wi-Fi/Bluetooth
- High efficiency
- Excellent performance



### 3 Product Specifications

#### Passive Electrical Specifications

Frequency Range	2400–2500 MHz
Input Impedence	50 $\Omega$
Return Loss	$\leq -10.2$
Efficiency	71 % (average)
Gain	$\leq 5.0$ dBi
Polarization Type	Linear

#### Mechanical Specifications

Antenna Size	5.2 mm × 2.0 mm × 1.2 mm
Casing	-
Radiator	Ceramic patch
Connector Type	SMD
Working Temperature	-40 °C to +85 °C
Radome Color	-

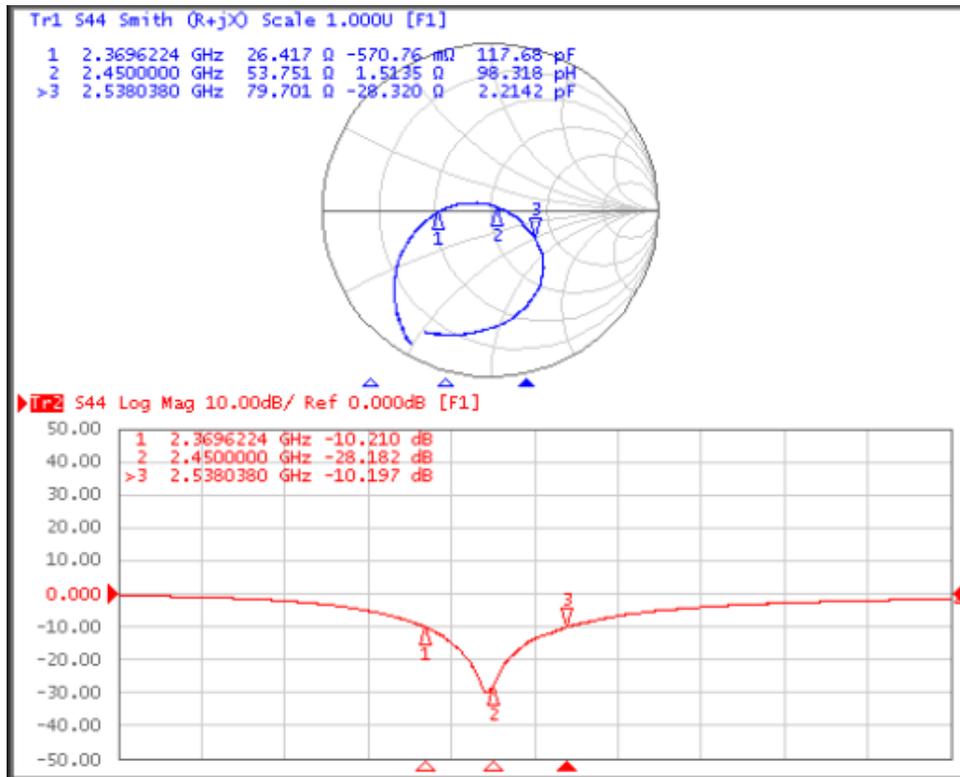
## 4 Overall Performance

### 4.1. Test Environment

- KEYSIGHT VNA Network Analyzer E5063A, 100 kHz – 8.5 GHz
- RayZone® 2800 Chamber 5G (FR1) SISO/MIMO, 600 MHz – 8.5 GHz



### 4.2. Return Loss



Frequency (MHz)	2369	2450	2538
Return Loss	-10.2	-28.2	-10.2

### 4.3. Efficiency

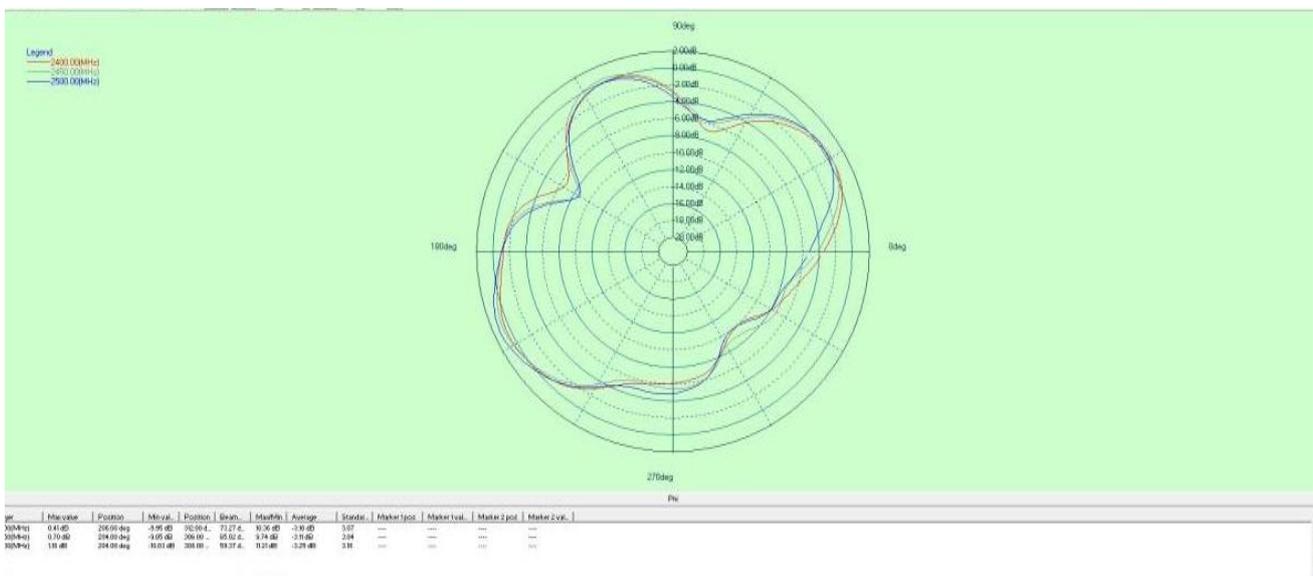
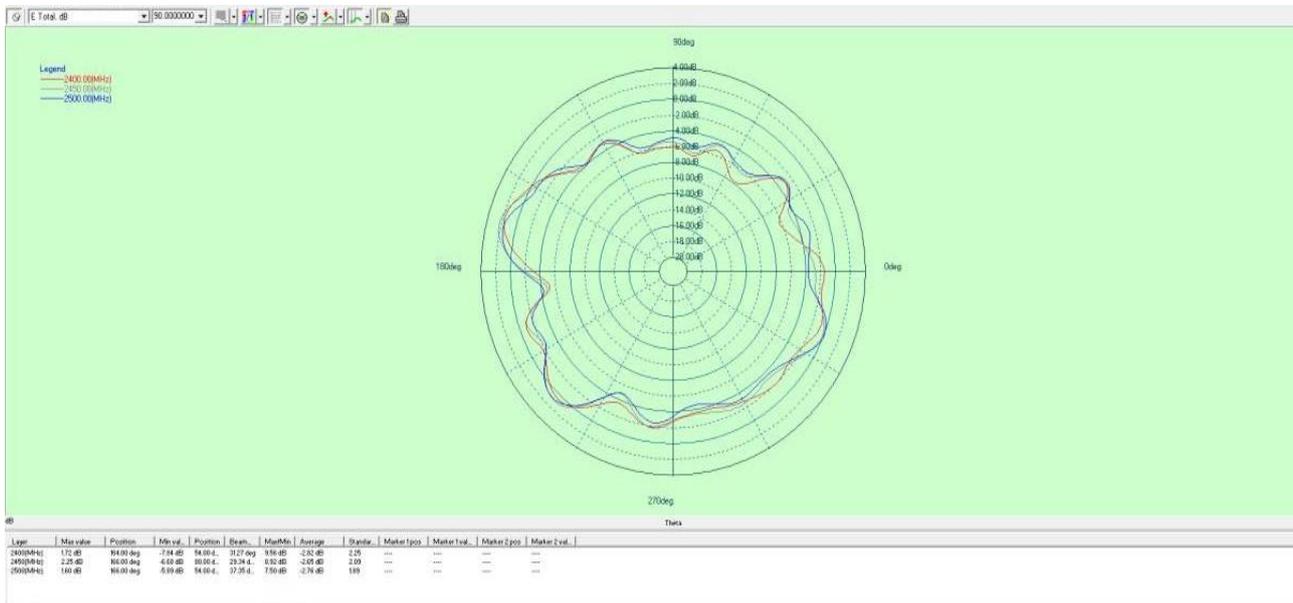
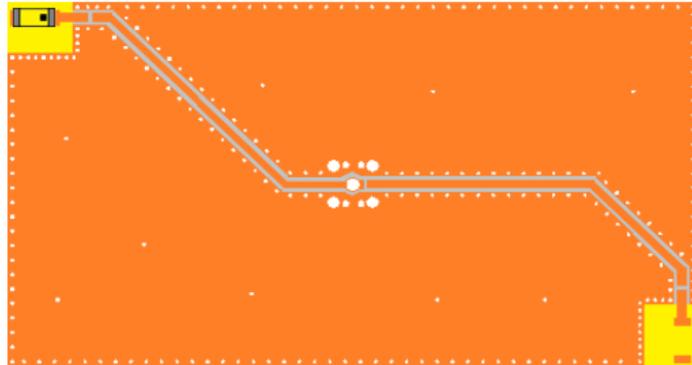
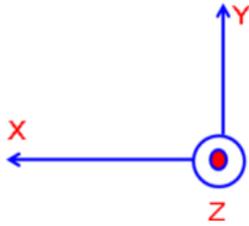
Frequency (MHz)	2400	2450	2500
Efficiency (%)	70.2	71.1	71.2

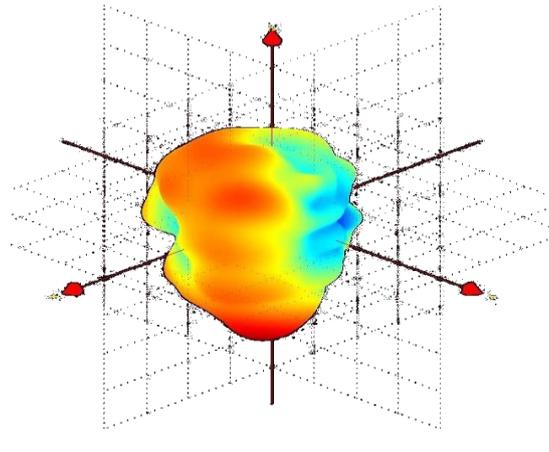
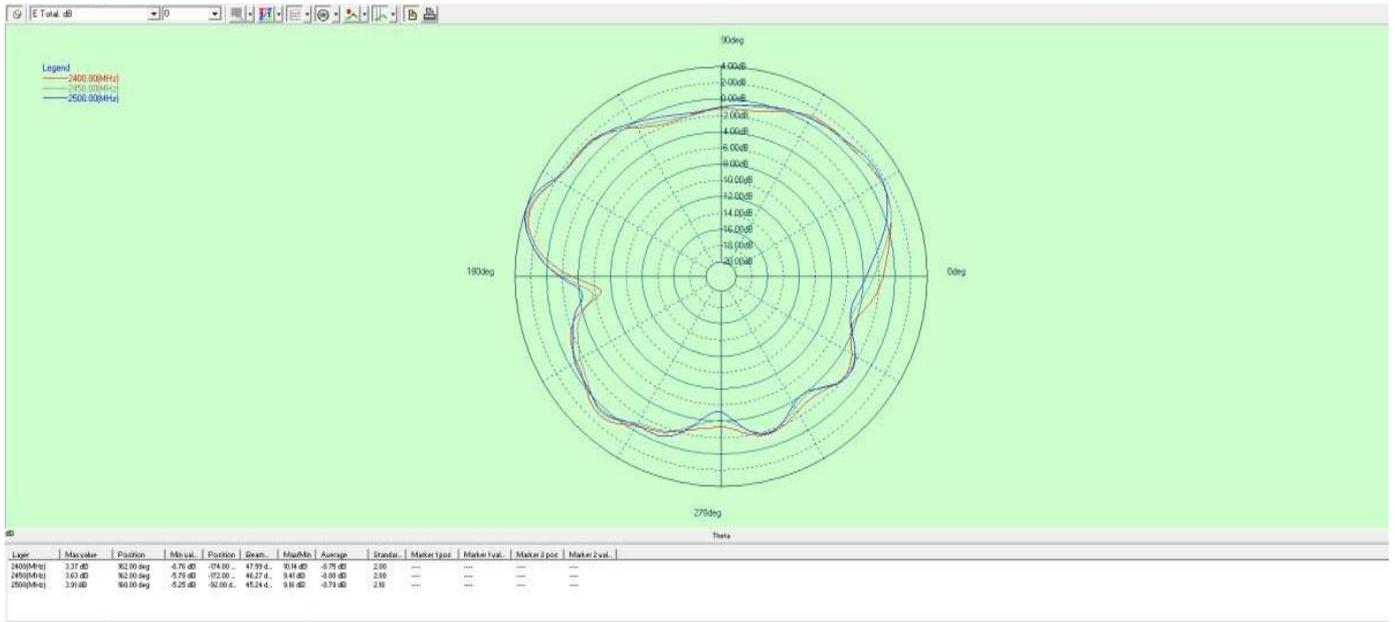
### 4.4. Gain

Frequency (MHz)	2400	2450	2500
Gain (dBi)	4.52	4.97	4.85

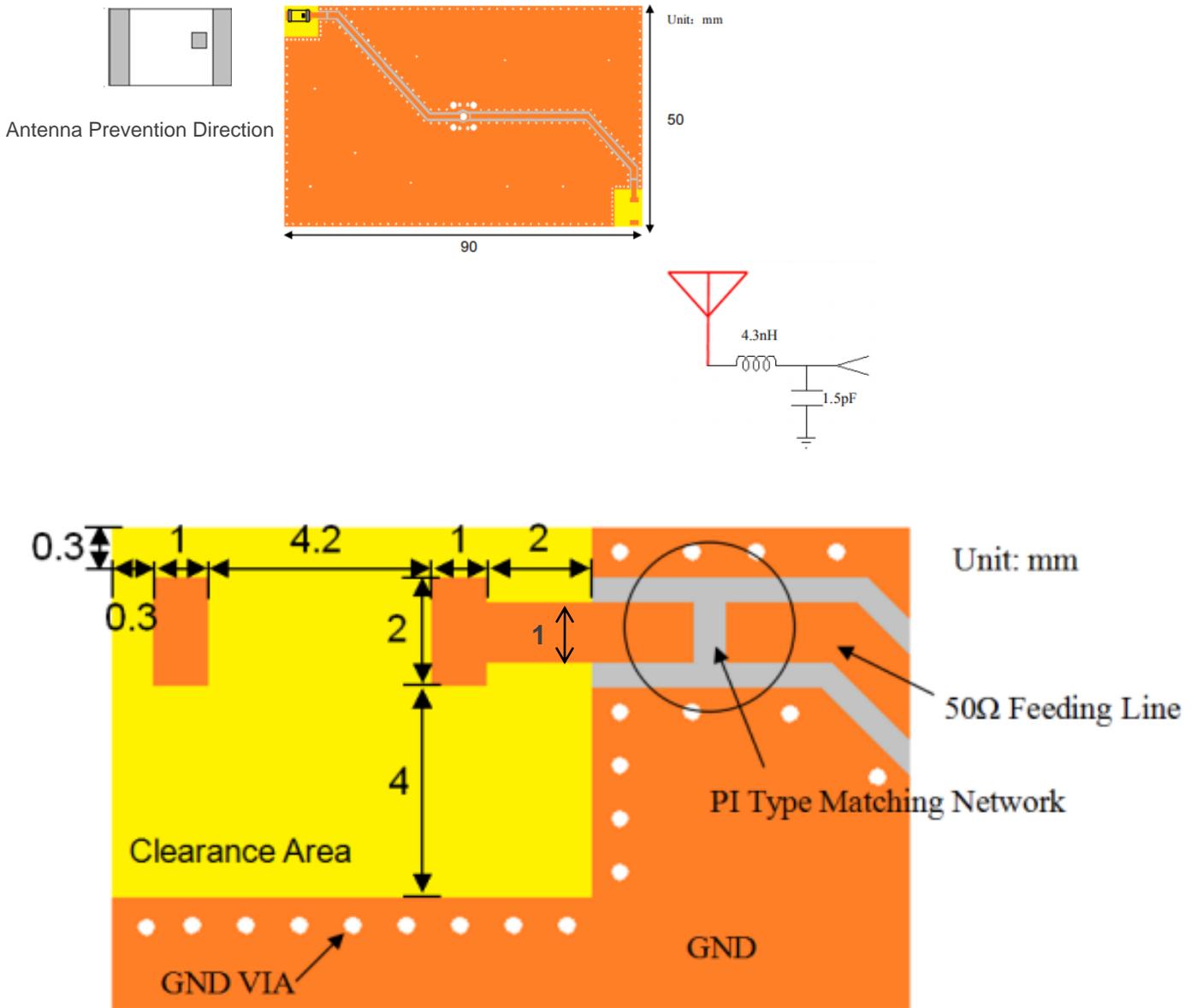
### 4.5. Radiation Pattern

coordinates:

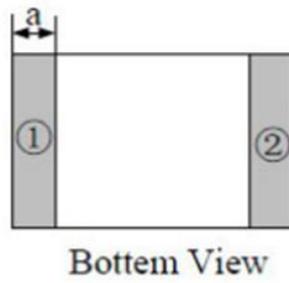
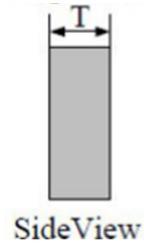
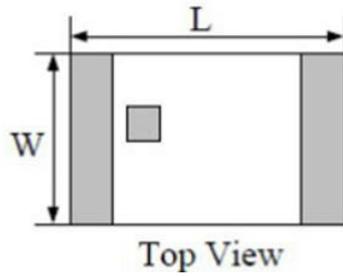




### 4.6. Reference PCB Design (Unit: mm)



### 5 Product Size (mm)



- L:  $5.2 \pm 0.2$
- W:  $2.0 \pm 0.2$
- ① T:  $1.2 \pm 0.1$
- ② a:  $0.5 \pm 0.1$

Unit: mm

## 6 Reliability Test

Temperature Range	25 ±5 °C
Relative Humidity Range	55–75 %
Operating Temperature Range	-40 °C to +85 °C
Storage Temperature Range	-40 °C to +85 °C

### 6.1. Vibration Resistance

The device should fulfil the electrical specification after being applied to the vibration of 10–55 Hz with amplitude of 1.5 mm for 2 hours in X, Y and Z directions respectively.

### 6.2. Drop and Shock Tests

The device should have no mechanical damage after dropping onto the hard wooden board from the height of 100 cm for 3 times at each facet of the 3 dimensions of the device.

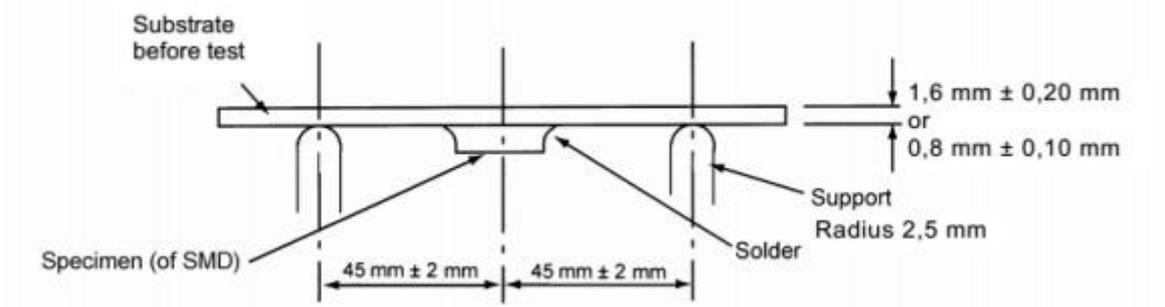
### 6.3. Resistance to Soldering Heat

The device should have no damage after pre-heating at 120–150 °C for 120 seconds and immersion in Sn solder at 255 ±10 °C for 5 ±0.5 seconds, or electric iron at 300 ±10 °C for 3 ±0.5 seconds.

### 6.4. Adhesive Strength of Termination

The device should have no remarkable damage or removal of the termination after horizontal force of 5 N ( $\leq$  0603); 10 N ( $>$  0603) for 10 ±1 seconds.

### 6.5. Bending Resistance Test



Weld the product to the central part of the PCB with the thickness  $1.6 \pm 0.2$  mm or  $0.8 \pm 0.1$  mm as the illustration shows, and keep exerting force arrow-ward on it at speed of 1 mm/s, and hold for  $5 \pm 1$  seconds at the position of 1.5 mm bending distance, so far, any peeling-off of the product metal coating should not be detected.

### 6.6. Moisture Proof

The device should fulfil the electrical specification after being exposed to the temperature  $60 \pm 2$  °C and the relative humidity 90–95 % for 96 hours and experiencing 1–2 hours recovery time under normal condition.

### 6.7. High Temperature Endurance

The device should fulfil the electrical specification after being exposed to temperature  $85 \pm 5$  °C for  $96 \pm 2$  hours and experiencing 1–2 hours recovery time under normal temperature.

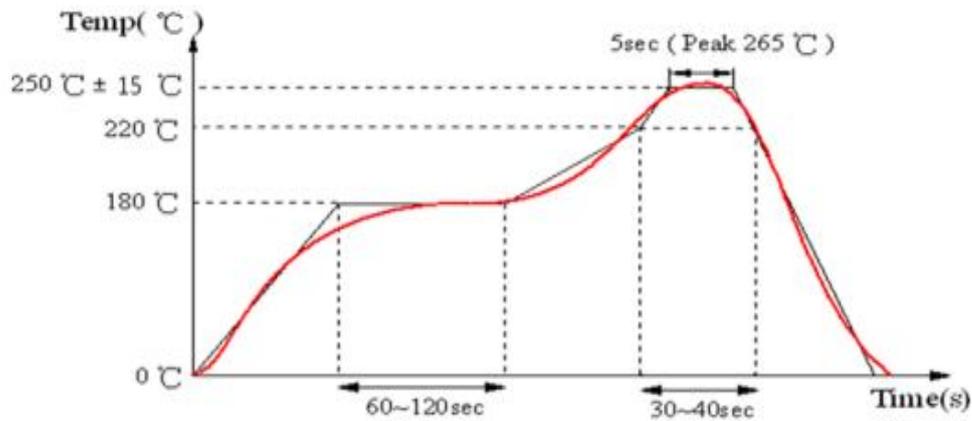
### 6.8. Low Temperature Endurance

The device should fulfil the electrical specification after being exposed to the temperature  $-40 \pm 5$  °C for  $96 \pm 2$  hours and experiencing 2 hours recovery time under normal temperature.

### 6.9. Temperature Cycle Test

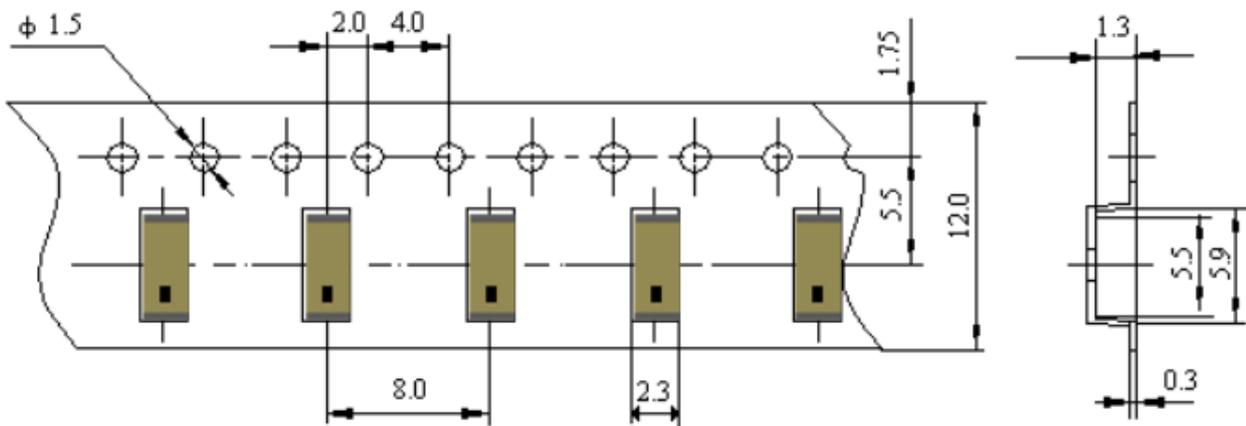
The device should fulfil the electrical specification after being exposed to the low temperature  $-40$  °C and high temperature  $+85$  °C for  $30 \pm 2$  minutes each by 5 cycles and experiencing 1 to 2 hours recovery time under normal temperature.

## 7 Reflow Soldering Standard Condition



## 8 Packaging and Dimensions

### 8.1. Plastic Tape



#### Packaging Note:

Reserve 150–200 mm of space at the trailing end of the carrier, 250–300 mm of space at the front end of the carrier and a further 250 mm space of cover tape at the front end of the carrier.

8.2. Reel (3000 pcs/reel)

